

SOT567A

leadless surface mounted package; plastic cap; 8 terminations

8 February 2016

Package information

1. Package summary

Terminal position code D (double)

Package type descriptive code DMAN8

Package type industry code DMAN8

Package style descriptive code DMAN (double-ended microelectronic

assembly; no leads)

Package style suffix code NA (not applicable)

Package body material type P (plastic)

Mounting method type S (surface mount)

Issue date 16-3-2006

Table 1. Package summary

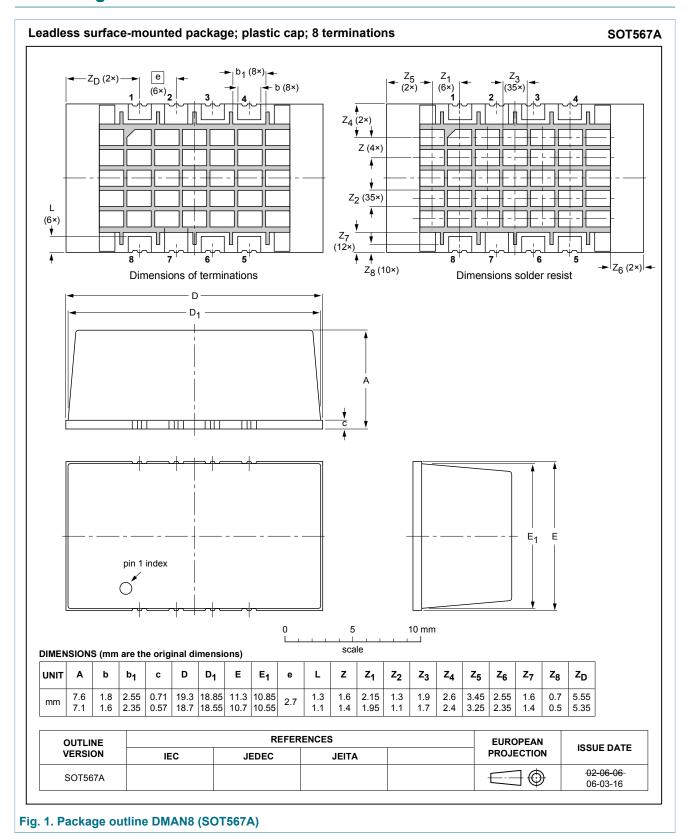
Symbol	Parameter	Min	Тур	Nom	Max	Unit
D	package length	18.7	-	19	19.3	mm
E	package width	10.7	-	11	11.3	mm
Α	seated height	7.1	-	7.35	7.6	mm
n ₂	actual quantity of termination	-	-	8	-	



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2. Package outline



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3. Legal information

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